



General Description

The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® S series is optimized for its switching characteristics to achieve aggressive EMI standards. It is easy to use for smaller power supply systems to meet the both efficiency and EMI standards.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity



Applications

- LED lighting
- Charger
- Adapter
- Telecom power
- Server power
- Solar/UPS

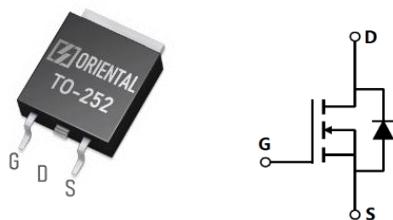
Key Performance Parameters

Parameter	Value	Unit
$V_{DS, min} @ T_{j(max)}$	650	V
$I_D, pulse$	33	A
$R_{DS(ON), max} @ V_{GS}=10V$	0.36	Ω
Q_g	20	nC

Marking Information

Product Name	Package	Marking
OSG60R360DSF	TO252	OSG60R360DS

Package & Pin Information



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	600	V
Gate-source voltage	V_{GS}	± 30	V
Continuous drain current ¹⁾ , $T_C=25^\circ\text{C}$	I_D	11	A
Continuous drain current ¹⁾ , $T_C=100^\circ\text{C}$		7	
Pulsed drain current ²⁾ , $T_C=25^\circ\text{C}$	$I_{D, \text{pulse}}$	33	A
Continuous diode forward current ¹⁾ , $T_C=25^\circ\text{C}$	I_S	11	A
Diode pulsed current ²⁾ , $T_C=25^\circ\text{C}$	$I_{S, \text{pulse}}$	33	A
Power dissipation ³⁾ , $T_C=25^\circ\text{C}$	P_D	89	W
Single pulsed avalanche energy ⁵⁾	E_{AS}	270	mJ
MOSFET dv/dt ruggedness, $V_{DS}=0\ldots 480\text{ V}$	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0\ldots 480\text{ V}$, $I_{SD} \leq I_D$	dv/dt	15	V/ns
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	$R_{\theta JC}$	1.4	°C/W
Thermal resistance, junction-ambient ⁴⁾	$R_{\theta JA}$	62	°C/W

Electrical Characteristics at $T_j=25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	600			V	$V_{GS}=0\text{ V}$, $I_D=250\text{ uA}$
		650				$V_{GS}=0\text{ V}$, $I_D=250\text{ uA}$, $T_j=150^\circ\text{C}$
Gate threshold voltage	$V_{GS(\text{th})}$	2.9		3.9	V	$V_{DS}=V_{GS}$, $I_D=250\text{ uA}$
Drain-source on-state resistance	$R_{DS(\text{ON})}$		0.3	0.36	Ω	$V_{GS}=10\text{ V}$, $I_D=5.5\text{ A}$
			0.73			$V_{GS}=10\text{ V}$, $I_D=5.5\text{ A}$, $T_j=150^\circ\text{C}$
Gate-source leakage current	I_{GSS}			100	nA	$V_{GS}=30\text{ V}$
				-100		$V_{GS}=-30\text{ V}$
Drain-source leakage current	I_{DSS}			1	μA	$V_{DS}=600\text{ V}$, $V_{GS}=0\text{ V}$
Gate resistance	R_G		16.5		Ω	$f=1\text{ MHz}$, Open drain

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C _{iss}		846.8		pF	V _{GS} =0 V, V _{DS} =50 V, f=100 KHz
Output capacitance	C _{oss}		71.1		pF	
Reverse transfer capacitance	C _{rss}		3.9		pF	
Turn-on delay time	t _{d(on)}		26.4		ns	V _{GS} =10 V, V _{DS} =400 V, R _G =2 Ω, I _D =11 A
Rise time	t _r		18		ns	
Turn-off delay time	t _{d(off)}		60.7		ns	
Fall time	t _f		25.1		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q _g		20		nC	V _{GS} =11 V, V _{DS} =400 V, I _D =10 A
Gate-source charge	Q _{gs}		5.9		nC	
Gate-drain charge	Q _{gd}		7.1		nC	
Gate plateau voltage	V _{plateau}		5.5		V	

Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	V _{SD}			1.4	V	I _S =11 A, V _{GS} =0 V
Reverse recovery time	t _{rr}		310.9		ns	V _R =400 V, I _S =11 A, di/dt=100 A/μs
Reverse recovery charge	Q _{rr}		3.8		μC	
Peak reverse recovery current	I _{rrm}		22.1		A	

Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of R_{θJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.
- 5) V_{DD}=100 V, V_{GS}=10 V, L=80 mH, starting T_j=25 °C.

Electrical Characteristics Diagrams

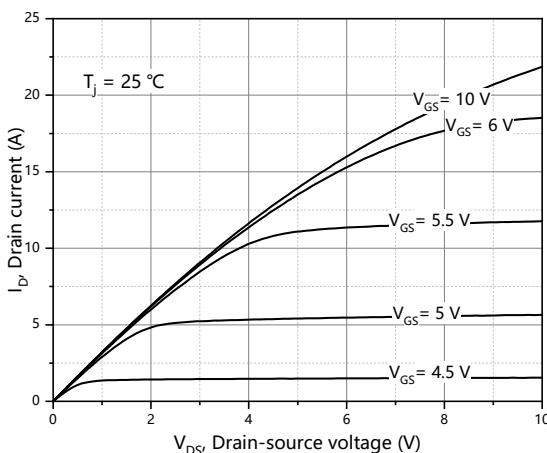


Figure 1. Typ. output characteristics

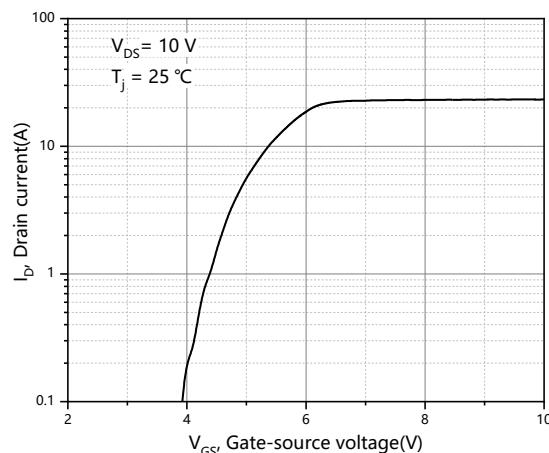


Figure 2. Typ. transfer characteristics

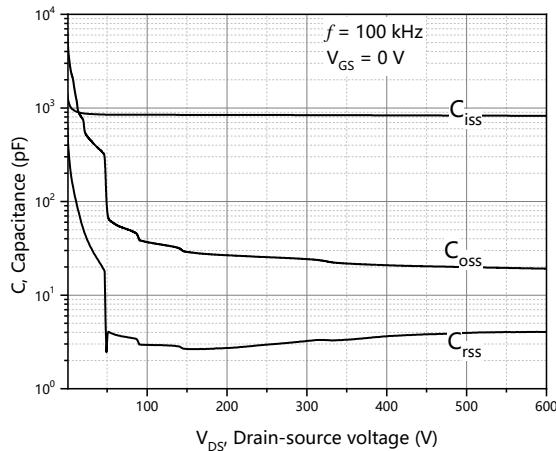


Figure 3. Typ. capacitances

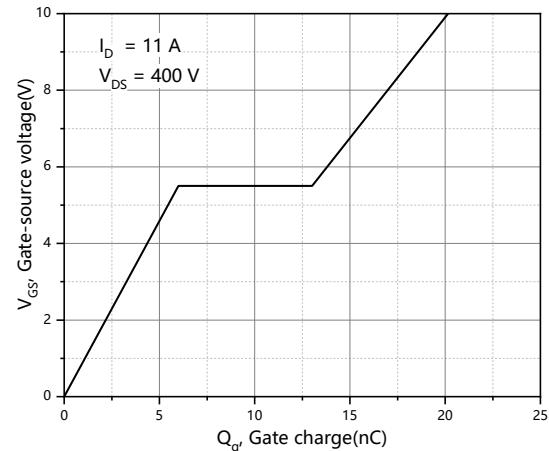


Figure 4. Typ. gate charge

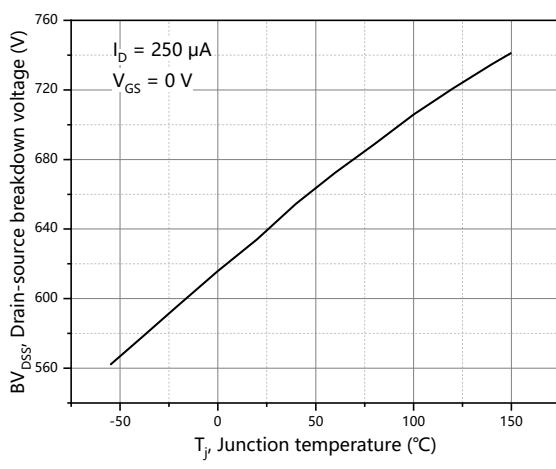


Figure 5. Drain-source breakdown voltage

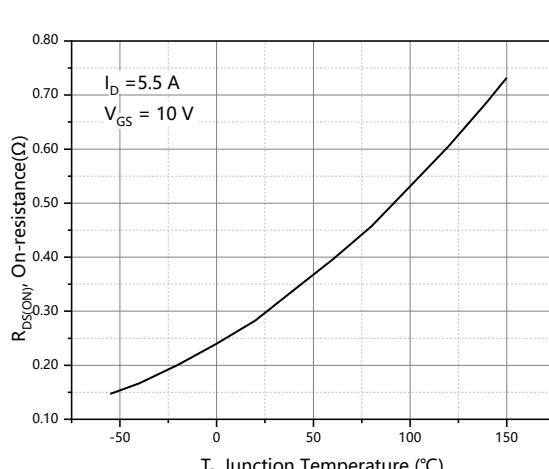
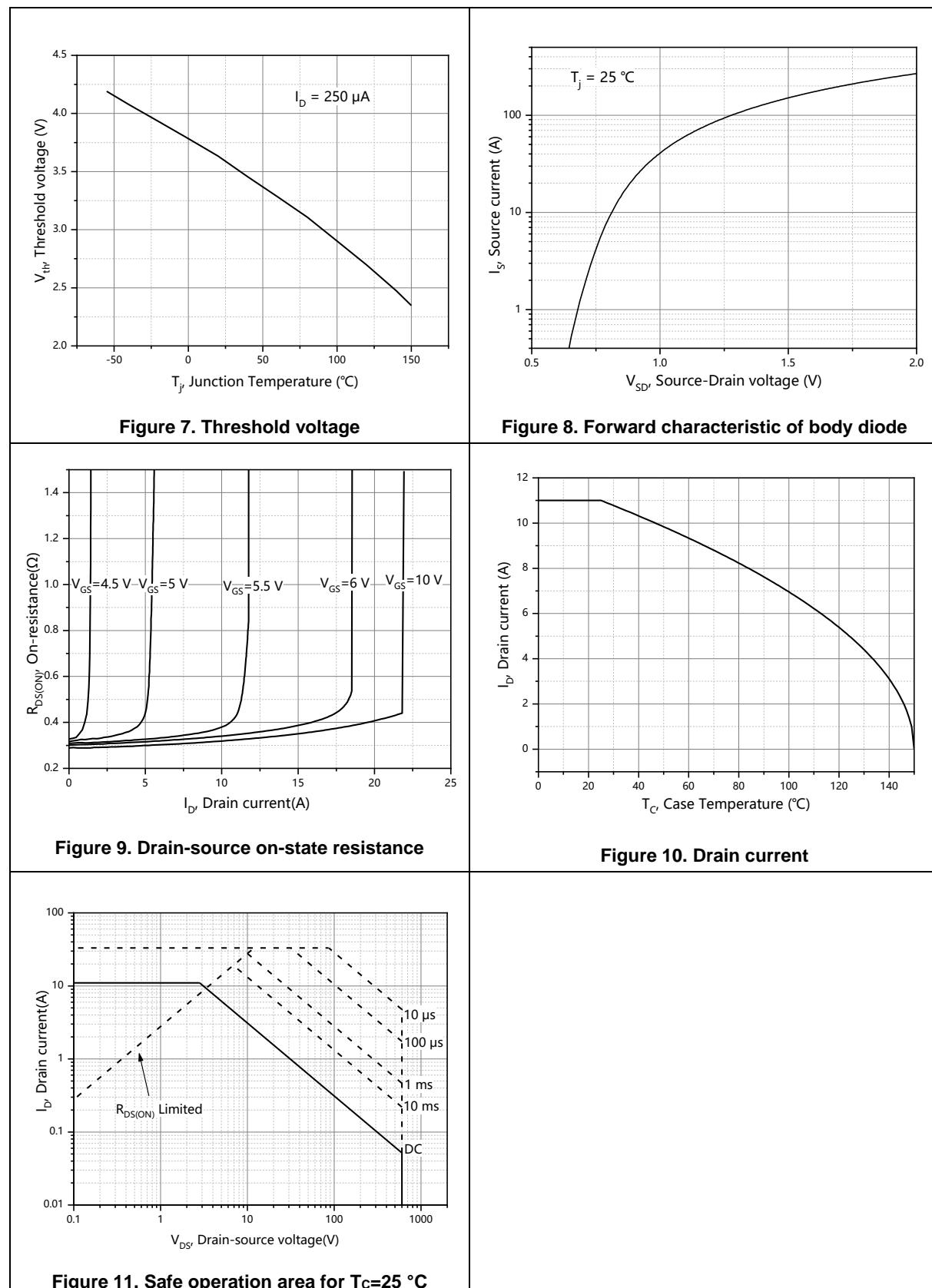


Figure 6. Drain-source on-state resistance



Test circuits and waveforms

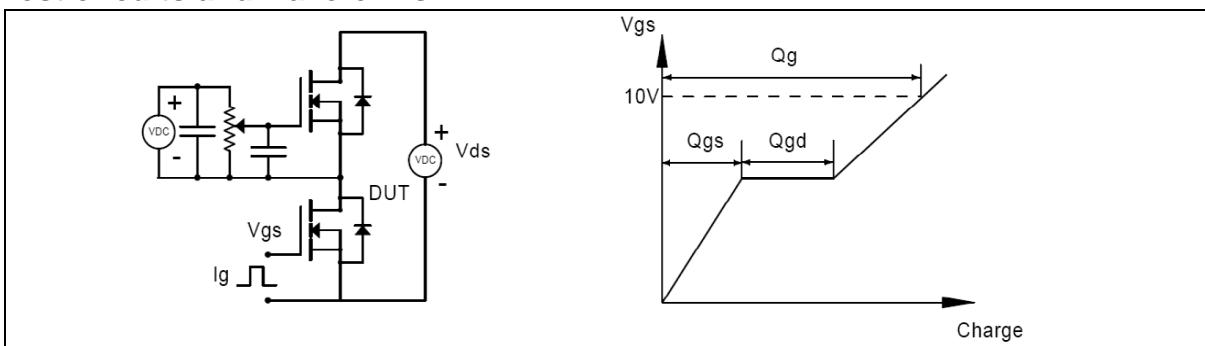


Figure 1. Gate charge test circuit & waveform

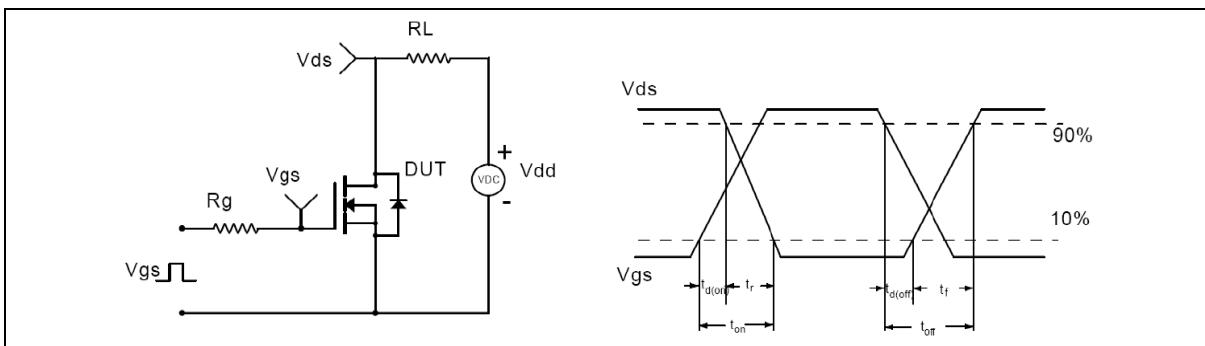


Figure 2. Switching time test circuit & waveforms

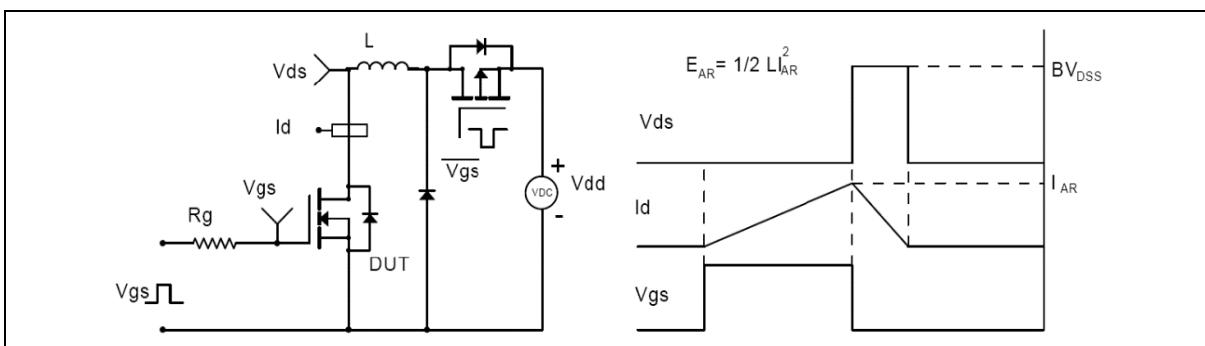


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

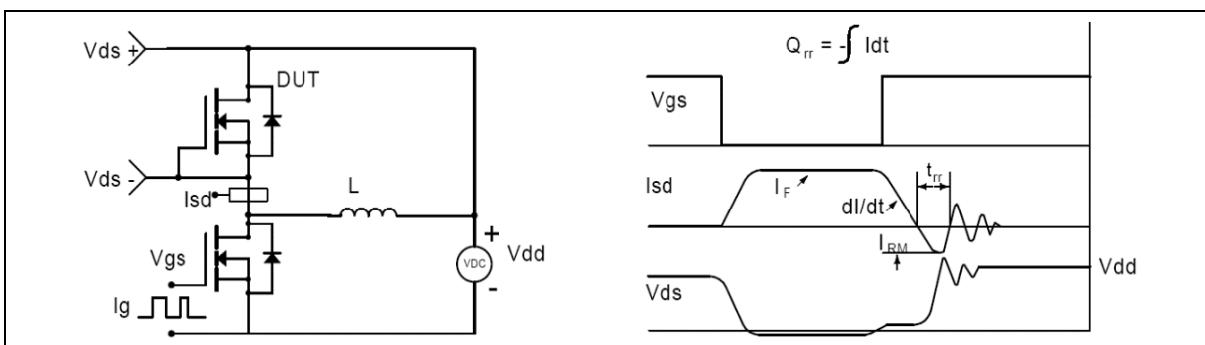
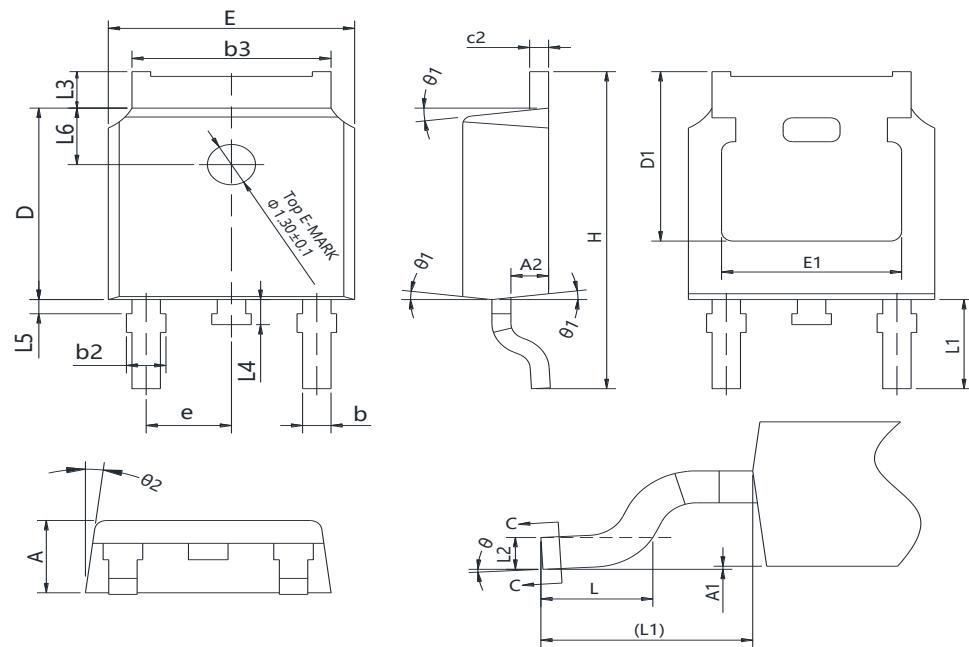


Figure 4. Diode reverse recovery test circuit & waveforms

Package Information



Symbol	mm		
	Min	Nom	Max
A	2.20	2.30	2.38
A1	0.00	-	0.10
A2	0.90	1.01	1.10
b	0.72	-	0.85
b1	0.71	0.76	0.81
b2	0.72	-	0.90
b3	5.13	5.33	5.46
c	0.47	-	0.60
c1	0.46	0.51	0.56
c2	0.47	-	0.60
D	6.00	6.10	6.20
D1	5.25	-	-
E	6.50	6.60	6.70
E1	4.70	-	-
e	2.186	2.286	2.386
H	9.80	10.10	10.40
L	1.40	1.50	1.70
L1	2.90REF		
L2	0.508BSC		
L3	0.90	-	1.25
L4	0.60	0.80	1.00
L5	0.15	-	0.75
L6	1.80REF		
θ	0°	-	8°
θ1	5°	7°	9°
θ2	5°	7°	9°

Version 1: TO252-J outline dimension



Ordering Information

Package Type	Units/Reel	Reels / Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO252-J	2500	2	5000	5	25000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG60R360DSF	TO252	yes	yes	yes

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